

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3054254

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Uming Ko	12/05/2012
Gordon Gammie	12/05/2012
Alice Wang	12/05/2012
RECEIVING PARTY DATA	
Name:	MediaTek Singapore Pte. Ltd.
Street Address:	No. 1 Fusionopolis Walk, #03-01 Solaris
City:	Singapore
State/Country:	SINGAPORE
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14507844
CORRESPONDENCE DATA	
Fax Number:	(703)997-4517
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Address Line 4:	MERRIFIELD, VIRGINIA 22116
ATTORNEY DOCKET NUMBER:	MSLP0325USA3
NAME OF SUBMITTER:	SHELLEY KUO
SIGNATURE:	/SHELLEY KUO/
DATE SIGNED:	10/07/2014
Total Attachments: 4	
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source=2072231#page2.tif	
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source=2072231#page4.tif	

PATENT

Docket No MSLP0214USA

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Uming Ko Nationality: US

Name: Gordon Gammie Nationality: US

Name: Alice Wang Nationality: US

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: MediaTek Singapore Pte. Ltd.

Address: No. 1 Fusionopolis Walk, #03-01 Solaris, Singapore 138628, Singapore

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"PERFORMANCE, THERMAL AND POWER MANAGEMENT SYSTEM ASSOCIATED WITH AN INTEGRATED CIRCUIT AND RELATED METHOD"

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____
(e) _____ International application no. _____

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

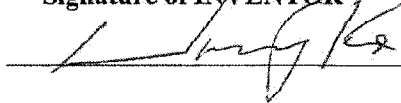
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this DEC 05 2012 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Uming Ko



Gordon Gammie

Alice Wang

PATENT

Docket No MSLP0214USA

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In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):Name: Uming Ko Nationality: USName: Gordon Gammie Nationality: USName: Alice Wang Nationality: US

Hereby sells, assigns and transfers to

ASSIGNEE(S):Name: MediaTek Singapore Pte. Ltd.Address: No. 1 Fusionopolis Walk, #03-01 Solaris, Singapore 138628, Singapore

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"PERFORMANCE, THERMAL AND POWER MANAGEMENT SYSTEM ASSOCIATED WITH
AN INTEGRATED CIRCUIT AND RELATED METHOD"

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____
(e) _____ International application no. _____

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

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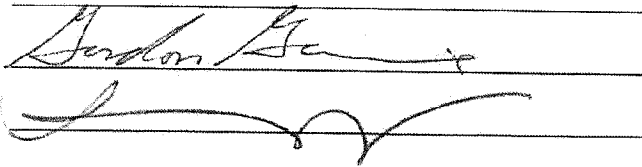
(Type name of inventor)

Signature of INVENTOR

Uming Ko

Gordon Gammie

Alice Wang

The image shows two handwritten signatures on a lined background. The first signature, for Gordon Gammie, is written in dark ink and is somewhat cursive. The second signature, for Alice Wang, is also in dark ink and is more fluid and cursive. Both signatures are positioned above their respective printed names.